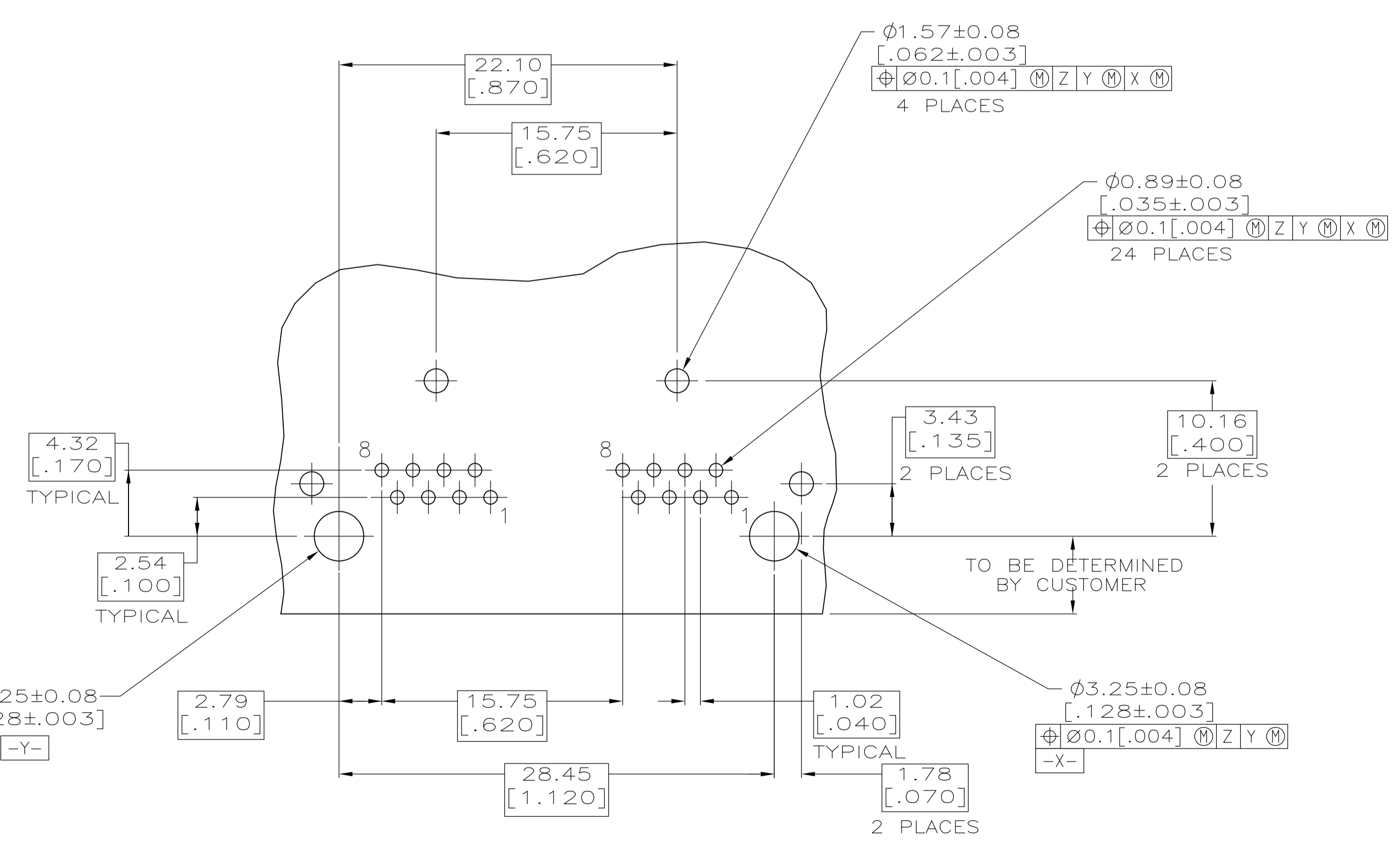


- △ MATERIAL: POLYESTER LCP  
BLACK, UL94V-0; LEAD FREE IR REFLOW SOLDERING PROCESS COMPATIBLE.  
TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [.000050] MINIMUM THICK NICKEL.  
SHIELD - 0.196[.0077] THICK COPPER ZINC ALLOY PREPLATED WITH 1.27µm[.000050] MINIMUM SATIN NICKEL WITH 2.03µm[.000080] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
- 2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
- △ SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
- △ THE CUSTOMER FEEDING DIRECTION IS THE OPPOSITE DIRECTION WITH 2170358-1



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT (COMPONENT SIDE)

TAPE&REEL	2170358-2
TAPE&REEL	2170358-1
PACKAGE	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN J. JEREMY 29JUN2012		STE TE Connectivity	
DIMENSIONS: mm [INCHES]		CIR J. JEREMY 29JUN2012		NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD G. ALEX 29JUN2012		INVERTED MODULAR JACK ASSEMBLY, 1X2, SHIELDED, PANEL GROUND	
0 PLC ± -	1 PLC ± -	PRODUCT SPEC		108-1163-4	
2 PLC ± 0.25[.01]	3 PLC ± 0.13[.005]	APPLICATION SPEC		114-2154	
4 PLC ± -	ANGLES ± -	SIZE		CAGE CODE DRAWING NO	
MATERIAL △	FINISH △	WEIGHT		RESTRICTED TO	
		A1 00779		CUSTOMER DRAWING	
		SCALE 4:1		SHEET 1 OF 1	
				REV A	